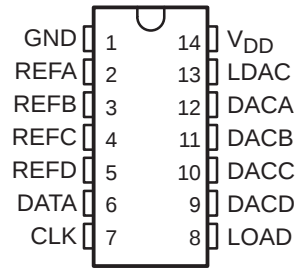


# TLV5620C, TLV5620I QUADRUPLE 8-BIT DIGITAL-TO-ANALOG CONVERTERS

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- Four 8-Bit Voltage Output DACs
- 3-V Single-Supply Operation
- Serial Interface
- High-Impedance Reference Inputs
- Programmable for 1 or 2 Times Output Range
- Simultaneous Update Facility
- Internal Power-On Reset
- Low-Power Consumption
- Half-Buffered Output

D OR N PACKAGE  
(TOP VIEW)



## applications

- Programmable Voltage Sources
- Digitally Controlled Amplifiers/Attenuators
- Mobile Communications
- Automatic Test Equipment
- Process Monitoring and Control
- Signal Synthesis

## description

The TLV5620C and TLV5620I are quadruple 8-bit voltage output digital-to-analog converters (DACs) with buffered reference inputs (high impedance). The DACs produce an output voltage that ranges between either one or two times the reference voltages and GND; and, the DACs are monotonic. The device is simple to use, because it runs from a single supply of 3 V to 3.6 V. A power-on reset function is incorporated to ensure repeatable start-up conditions.

Digital control of the TLV5620C and TLV5620I is over a simple three-wire serial bus that is CMOS compatible and easily interfaced to all popular microprocessor and microcontroller devices. The 11-bit command word comprises eight bits of data, two DAC select bits, and a range bit, the latter allowing selection between the times 1 or times 2 output range. The DAC registers are double buffered, allowing a complete set of new values to be written to the device, then all DAC outputs update simultaneously through control of LDAC. The digital inputs feature Schmitt triggers for high noise immunity.

The 14-terminal small-outline (SO) package allows digital control of analog functions in space-critical applications. The TLV5620C is characterized for operation from 0°C to 70°C. The TLV5620I is characterized for operation from –40°C to 85°C. The TLV5620C and TLV5620I do not require external trimming.

AVAILABLE OPTIONS

| T <sub>A</sub> | PACKAGE           |                 |
|----------------|-------------------|-----------------|
|                | SMALL OUTLINE (D) | PLASTIC DIP (N) |
| 0°C to 70°C    | TLV5620CD         | TLV5620CN       |
| –40°C to 85°C  | TLV5620ID         | TLV5620IN       |



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

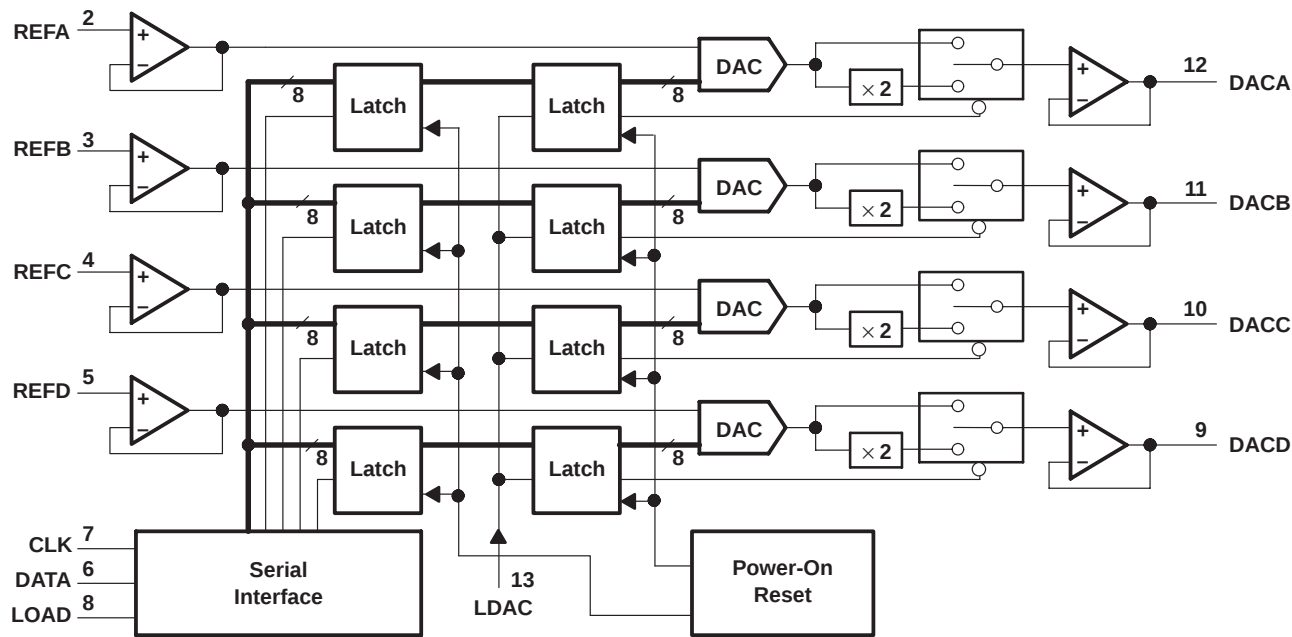
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TLV5620C, TLV5620I  
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functional block diagram



Terminal Functions

| TERMINAL<br>NAME | NO. | I/O | DESCRIPTION                                                                                                                                                                                                              |
|------------------|-----|-----|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CLK              | 7   | I   | Serial interface clock. The input digital data is shifted into the serial interface register on the falling edge of the clock applied to the CLK terminal.                                                               |
| DACA             | 12  | O   | DAC A analog output                                                                                                                                                                                                      |
| DACB             | 11  | O   | DAC B analog output                                                                                                                                                                                                      |
| DACC             | 10  | O   | DAC C analog output                                                                                                                                                                                                      |
| DACD             | 9   | O   | DAC D analog output                                                                                                                                                                                                      |
| DATA             | 6   | I   | Serial interface digital data input. The digital code for the DAC is clocked into the serial interface register serially. Each data bit is clocked into the register on the falling edge of the clock signal.            |
| GND              | 1   | I   | Ground return and reference terminal                                                                                                                                                                                     |
| LDAC             | 13  | I   | Load DAC. When this signal is high, no DAC output updates occur when the input digital data is read into the serial interface. The DAC outputs are only updated when LDAC is taken from high to low.                     |
| LOAD             | 8   | I   | Serial interface load control. When the LDAC terminal is low, the falling edge of the LOAD signal latches the digital data into the output latch and immediately produces the analog voltage at the DAC output terminal. |
| REFA             | 2   | I   | Reference voltage input to DAC A. This voltage defines the output analog range.                                                                                                                                          |
| REFB             | 3   | I   | Reference voltage input to DAC B. This voltage defines the analog output range.                                                                                                                                          |
| REFC             | 4   | I   | Reference voltage input to DAC C. This voltage defines the analog output range.                                                                                                                                          |
| REFD             | 5   | I   | Reference voltage input to DAC D. This voltage defines the analog output range.                                                                                                                                          |
| VDD              | 14  | I   | Positive supply voltage                                                                                                                                                                                                  |

## detailed description

The TLV5620 is implemented using four resistor-string DACs. The core of each DAC is a single resistor with 256 taps, corresponding to the 256 possible codes listed in Table 1. One end of each resistor string is connected to GND and the other end is fed from the output of the reference input buffer. Monotonicity is maintained by use of the resistor strings. Linearity depends upon the matching of the resistor segments and upon the performance of the output buffer. Since the inputs are buffered, the DACs always presents a high-impedance load to the reference source.

Each DAC output is buffered by a configurable-gain output amplifier, which can be programmed to times 1 or times 2 gain.

On power up, the DACs are reset to CODE 0.

Each output voltage is given by:

$$V_O(\text{DACA|B|C|D}) = \text{REF} \times \frac{\text{CODE}}{256} \times (1 + \text{RNG bit value})$$

where CODE is in the range 0 to 255 and the range (RNG) bit is a 0 or 1 within the serial control word.

**Table 1. Ideal Output Transfer**

| D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0 | OUTPUT VOLTAGE                               |
|----|----|----|----|----|----|----|----|----------------------------------------------|
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | GND                                          |
| 0  | 0  | 0  | 0  | 0  | 0  | 0  | 1  | $(1/256) \times \text{REF} (1+\text{RNG})$   |
| •  | •  | •  | •  | •  | •  | •  | •  | •                                            |
| •  | •  | •  | •  | •  | •  | •  | •  | •                                            |
| 0  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | $(127/256) \times \text{REF} (1+\text{RNG})$ |
| 1  | 0  | 0  | 0  | 0  | 0  | 0  | 0  | $(128/256) \times \text{REF} (1+\text{RNG})$ |
| •  | •  | •  | •  | •  | •  | •  | •  | •                                            |
| •  | •  | •  | •  | •  | •  | •  | •  | •                                            |
| 1  | 1  | 1  | 1  | 1  | 1  | 1  | 1  | $(255/256) \times \text{REF} (1+\text{RNG})$ |

## data interface

With LOAD high, data is clocked into the DATA terminal on each falling edge of CLK. Once all data bits have been clocked in, LOAD is pulsed low to transfer the data from the serial input register to the selected DAC as shown in Figure 1. When LDAC is low, the selected DAC output voltage is updated when LOAD goes low. When LDAC is high during serial programming, the new value is stored within the device and can be transferred to the DAC output at a later time by pulsing LDAC low as shown in Figure 2. Data is entered MSB first. Data transfers using two 8-clock-cycle periods are shown in Figures 3 and 4.

Table 2 lists the A1 and A0 bits and the selection of the updated DACs. The RNG bit controls the DAC output range. When RNG = low, the output range is between the applied reference voltage and GND, and when RNG = high, the range is between twice the applied reference voltage and GND.

**Table 2. Serial Input Decode**

| A1 | A0 | DAC UPDATED |
|----|----|-------------|
| 0  | 0  | DACA        |
| 0  | 1  | DACB        |
| 1  | 0  | DACC        |
| 1  | 1  | DACD        |

# TLV5620C, TLV5620I

## QUADRUPLE 8-BIT DIGITAL-TO-ANALOG CONVERTERS

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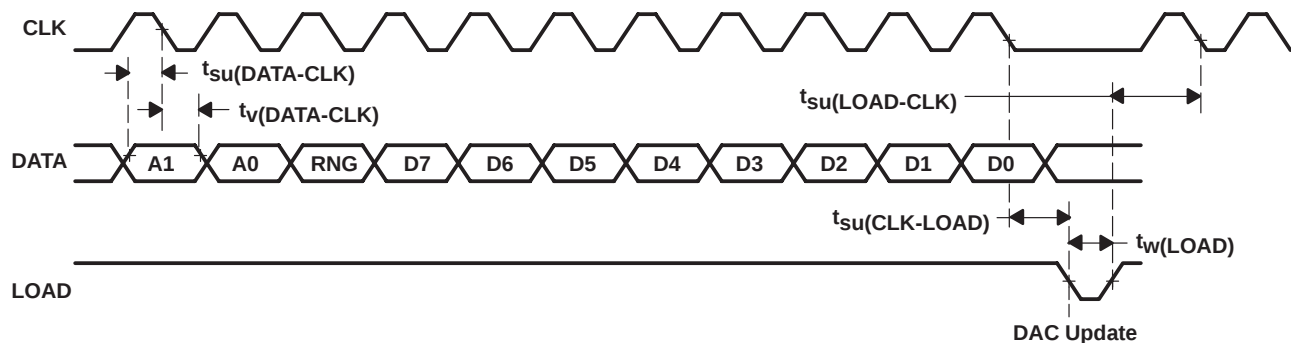


Figure 1. LOAD-Controlled Update (LDAC = Low)

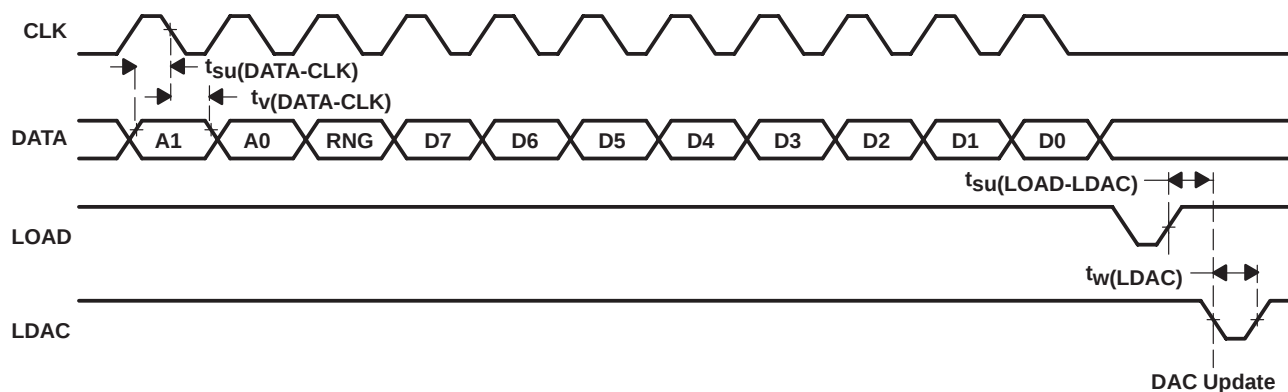


Figure 2. LDAC-Controlled Update

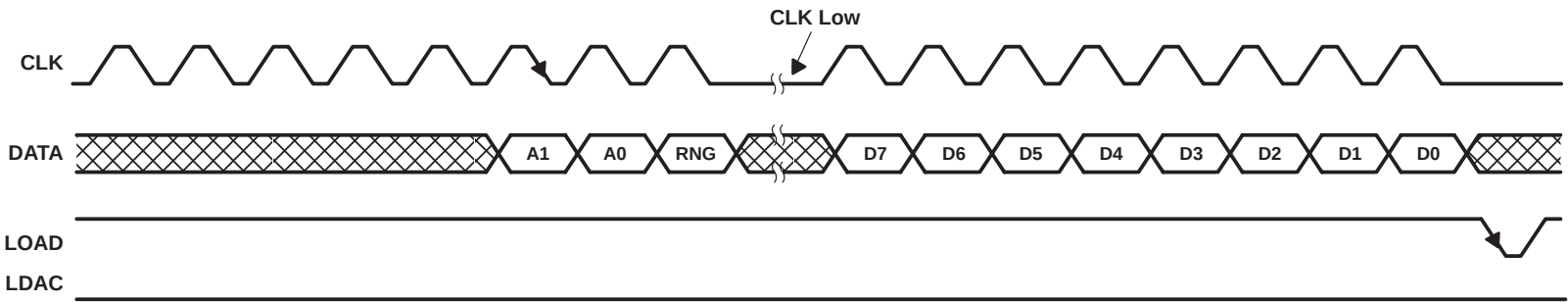


Figure 3. Load Controlled Update Using 8-Bit Serial Word (LDAC = Low)

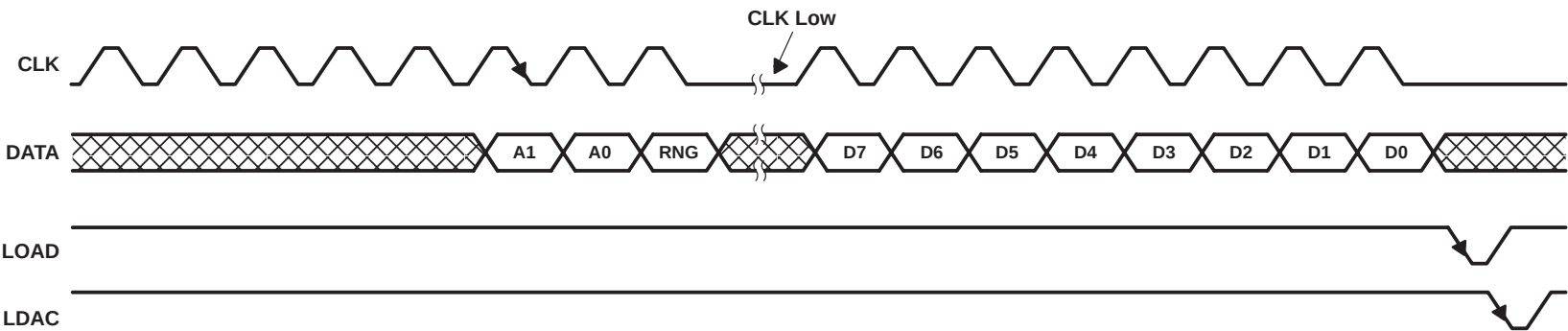


Figure 4. LDAC Controlled Update Using 8-Bit Serial Word

# TLV5620C, TLV5620I

## QUADRUPLE 8-BIT DIGITAL-TO-ANALOG CONVERTERS

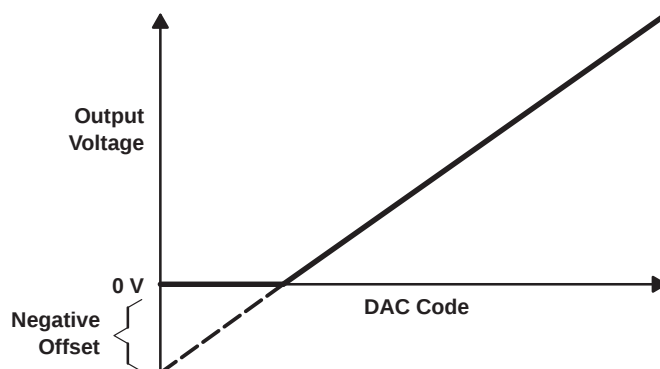
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### linearity, offset, and gain error using single-end supplies

When an amplifier is operated from a single supply, the voltage offset can still be either positive or negative. With a positive offset voltage, the output voltage changes on the first code change. With a negative offset the output voltage may not change with the first code depending on the magnitude of the offset voltage.

The output amplifier, therefore, attempts to drive the output to a negative voltage. However, because the most negative supply rail is ground, the output cannot drive below ground and clamps the output at 0 V.

The output voltage remains at zero until the input code value produces a sufficient positive output voltage to overcome the negative offset voltage, resulting in the transfer function shown in Figure 5.



**Figure 5. Effect of Negative Offset (Single Supply)**

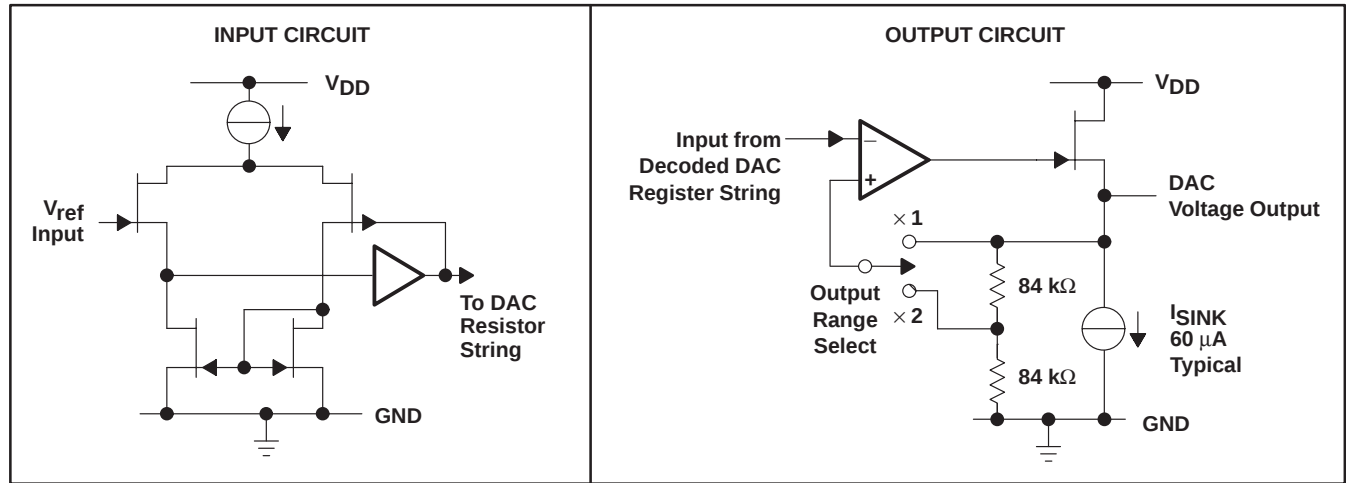
This offset error, not the linearity error, produces this breakpoint. The transfer function would have followed the dotted line if the output buffer could drive below ground.

For a DAC, linearity is measured between zero-input code (all inputs 0) and full-scale code (all inputs 1) after offset and full scale are adjusted out or accounted for in some way. However, single-supply operation does not allow for adjustment when the offset is negative due to the breakpoint in the transfer function. So the linearity is measured between full-scale code and the lowest code that produces a positive output voltage. The code is calculated from the maximum specification for the negative offset.

# TLV5620C, TLV5620I QUADRUPLE 8-BIT DIGITAL-TO-ANALOG CONVERTERS

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## equivalent inputs and outputs



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                              |                                   |
|--------------------------------------------------------------|-----------------------------------|
| Supply voltage ( $V_{DD} - GND$ )                            | 7 V                               |
| Digital input voltage range                                  | $GND - 0.3 V$ to $V_{DD} + 0.3 V$ |
| Reference input voltage range, $V_{ID}$                      | $GND - 0.3 V$ to $V_{DD} + 0.3 V$ |
| Operating free-air temperature range, $T_A$ : TLV5620C       | $0^\circ C$ to $70^\circ C$       |
| TLV5620I                                                     | $-40^\circ C$ to $85^\circ C$     |
| Storage temperature range, $T_{stg}$                         | $-50^\circ C$ to $150^\circ C$    |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | $260^\circ C$                     |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## recommended operating conditions

|                                                                                            | MIN          | NOM | MAX            | UNIT       |
|--------------------------------------------------------------------------------------------|--------------|-----|----------------|------------|
| Supply voltage, $V_{DD}$                                                                   | 2.7          | 3.3 | 5.25           | V          |
| High-level input voltage, $V_{IH}$                                                         | $0.8 V_{DD}$ |     |                | V          |
| Low-level input voltage, $V_{IL}$                                                          |              |     | 0.8            | V          |
| Reference voltage, $V_{ref}$ [A B C D], $\times 1$ gain                                    |              |     | $V_{DD} - 1.5$ | V          |
| Load resistance, $R_L$                                                                     | 10           |     |                | kΩ         |
| Setup time, data input, $t_{su}(DATA-CLK)$ (see Figures 1 and 2)                           | 50           |     |                | ns         |
| Valid time, data input valid after $CLK\downarrow$ , $t_v(DATA-CLK)$ (see Figures 1 and 2) | 50           |     |                | ns         |
| Setup time, CLK eleventh falling edge to LOAD, $t_{su}(CLK-LOAD)$ (see Figure 1)           | 50           |     |                | ns         |
| Setup time, $LOAD\uparrow$ to $CLK\downarrow$ , $t_{su}(LOAD-CLK)$ (see Figure 1)          | 50           |     |                | ns         |
| Pulse duration, LOAD, $t_w(LOAD)$ (see Figure 1)                                           | 250          |     |                | ns         |
| Pulse duration, LDAC, $t_w(LDAC)$ (see Figure 2)                                           | 250          |     |                | ns         |
| Setup time, $LOAD\uparrow$ to $LDAC\downarrow$ , $t_{su}(LOAD-LDAC)$ (see Figure 2)        | 0            |     |                | ns         |
| CLK frequency                                                                              |              |     | 1              | MHz        |
| Operating free-air temperature, $T_A$                                                      | TLV5620C     |     | 0              | $^\circ C$ |
|                                                                                            | TLV5620I     |     | -40            |            |



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# TLV5620C, TLV5620I

## QUADRUPLE 8-BIT DIGITAL-TO-ANALOG CONVERTERS

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**electrical characteristics over recommended operating free-air temperature range,  
V<sub>DD</sub> = 3 V to 3.6 V, V<sub>ref</sub> = 2 V, × 1 gain output range (unless otherwise noted)**

| PARAMETER              |                                          | TEST CONDITIONS                                   | MIN | TYP | MAX  | UNIT  |
|------------------------|------------------------------------------|---------------------------------------------------|-----|-----|------|-------|
| I <sub>IH</sub>        | High-level input current                 | V <sub>I</sub> = V <sub>DD</sub>                  |     |     | ±10  | μA    |
| I <sub>IL</sub>        | Low-level input current                  | V <sub>I</sub> = 0 V                              |     |     | ±10  | μA    |
| I <sub>O(sink)</sub>   | Output sink current                      | Each DAC output                                   | 20  |     |      | μA    |
| I <sub>O(source)</sub> | Output source current                    |                                                   | 1   |     |      | mA    |
| C <sub>i</sub>         | Input capacitance                        |                                                   |     | 15  |      | pF    |
|                        | Reference input capacitance              |                                                   |     | 15  |      |       |
| I <sub>DD</sub>        | Supply current                           | V <sub>DD</sub> = 3.3 V                           |     |     | 2    | mA    |
| I <sub>ref</sub>       | Reference input current                  | V <sub>DD</sub> = 3.3 V, V <sub>ref</sub> = 1.5 V |     |     | ±10  | μA    |
| E <sub>L</sub>         | Linearity error (end point corrected)    | V <sub>ref</sub> = 1.25 V, × 2 gain, See Note 1   |     |     | ±1   | LSB   |
| E <sub>D</sub>         | Differential linearity error             | V <sub>ref</sub> = 1.25 V, × 2 gain, See Note 2   |     |     | ±0.9 | LSB   |
| E <sub>ZS</sub>        | Zero-scale error                         | V <sub>ref</sub> = 1.25 V, × 2 gain, See Note 3   | 0   |     | 30   | mV    |
|                        | Zero-scale error temperature coefficient | V <sub>ref</sub> = 1.25 V, × 2 gain, See Note 4   |     | 10  |      | μV/°C |
| E <sub>FS</sub>        | Full-scale error                         | V <sub>ref</sub> = 1.25 V, × 2 gain, See Note 5   |     |     | ±60  | mV    |
|                        | Full-scale error temperature coefficient | V <sub>ref</sub> = 1.25 V, × 2 gain, See Note 6   |     | ±25 |      | μV/°C |
| PSRR                   | Power-supply sensitivity                 | See Notes 7 and 8                                 |     | 0.5 |      | mV/V  |

- NOTES: 1. Integral nonlinearity (INL) is the maximum deviation of the output from the line between zero and full scale (excluding the effects of zero code and full-scale errors).
2. Differential nonlinearity (DNL) is the difference between the measured and ideal 1 LSB amplitude change of any two adjacent codes. Monotonic means the output voltage changes in the same direction (or remains constant) as a change in the digital input code.
3. Zero-scale error is the deviation from zero voltage output when the digital input code is zero.
4. Zero-scale error temperature coefficient is given by:  $ZSETC = [ZSE(T_{max}) - ZSE(T_{min})]/V_{ref} \times 10^6/(T_{max} - T_{min})$ .
5. Full-scale error is the deviation from the ideal full-scale output (V<sub>ref</sub> – 1 LSB) with an output load of 10 kΩ.
6. Full-scale error temperature coefficient is given by:  $FSETC = [FSE(T_{max}) - FSE(T_{min})]/V_{ref} \times 10^6/(T_{max} - T_{min})$ .
7. Zero-scale error rejection ratio (ZSE-RR) is measured by varying the V<sub>DD</sub> voltage from 4.5 V to 5.5 V dc and measuring the effect of this signal on the zero-code output voltage.
8. Full-scale error rejection ratio (FSE-RR) is measured by varying the V<sub>DD</sub> voltage from 3 V to 3.6 V dc and measuring the effect of this signal on the full-scale output voltage.

**operating characteristics over recommended operating free-air temperature range,  
V<sub>DD</sub> = 3 V to 3.6 V, V<sub>ref</sub> = 2 V, × 1 gain output range (unless otherwise noted)**

|                              | TEST CONDITIONS                                                          | MIN | TYP | MAX | UNIT |
|------------------------------|--------------------------------------------------------------------------|-----|-----|-----|------|
| Output slew rate             | C <sub>L</sub> = 100 pF, R <sub>L</sub> = 10 kΩ                          |     | 1   |     | V/μs |
| Output settling time         | To ±0.5 LSB, C <sub>L</sub> = 100 pF, R <sub>L</sub> = 10 kΩ, See Note 9 |     | 10  |     | μs   |
| Large-signal bandwidth       | Measured at –3 dB point                                                  |     | 100 |     | kHz  |
| Digital crosstalk            | CLK = 1-MHz square wave measured at DACA-DACD                            |     | –50 |     | dB   |
| Reference feedthrough        | See Note 10                                                              |     | –60 |     | dB   |
| Channel-to-channel isolation | See Note 11                                                              |     | –60 |     | dB   |
| Reference input bandwidth    | See Note 12                                                              |     | 100 |     | kHz  |

- NOTES: 9. Settling time is the time between a LOAD falling edge and the DAC output reaching full-scale voltage within ± 0.5 LSB starting from an initial output voltage equal to zero.
10. Reference feedthrough is measured at any DAC output with an input code = 00 hex with a V<sub>ref</sub> input = 1 V dc + 1 V<sub>PP</sub> at 10 kHz.
11. Channel-to-channel isolation is measured by setting the input code of one DAC to FF hex and the code of all other DACs to 00 hex with V<sub>ref</sub> input = 1 V dc + 1 V<sub>PP</sub> at 10 kHz.
12. Reference bandwidth is the –3 dB bandwidth with an input at V<sub>ref</sub> = 1.25 V dc + 2 V<sub>PP</sub> and with a digital input code of full-scale.



PARAMETER MEASUREMENT INFORMATION

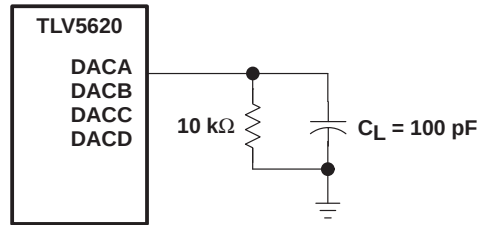
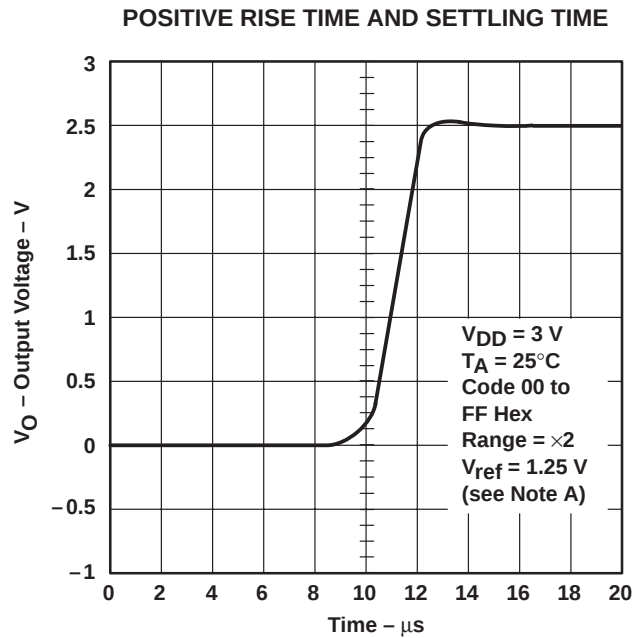


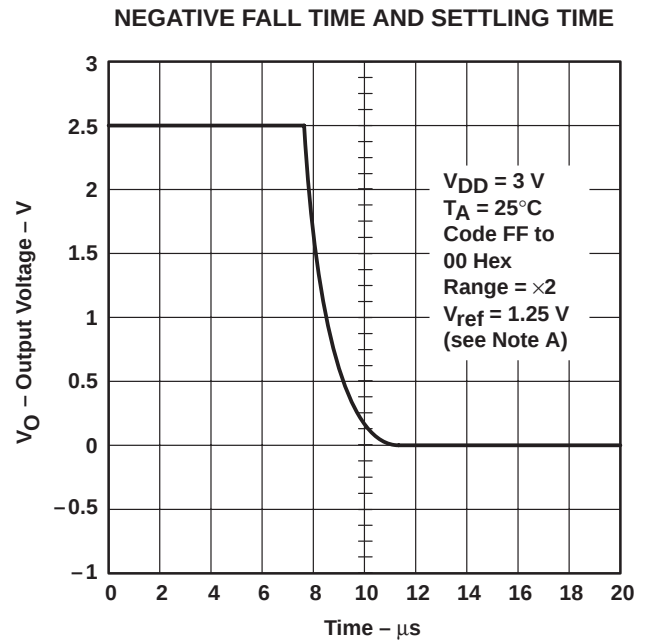
Figure 6. Slew, Settling Time, and Linearity Measurements

TYPICAL CHARACTERISTICS



NOTE A: Rise time = 2.05  $\mu$ s, positive slew rate = 0.96 V/ $\mu$ s, settling time = 4.5  $\mu$ s.

Figure 7



NOTE A: Fall time = 4.25  $\mu$ s, negative slew rate = 0.46 V/ $\mu$ s, settling time = 8.5  $\mu$ s.

Figure 8

TLV5620C, TLV5620I  
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TYPICAL CHARACTERISTICS

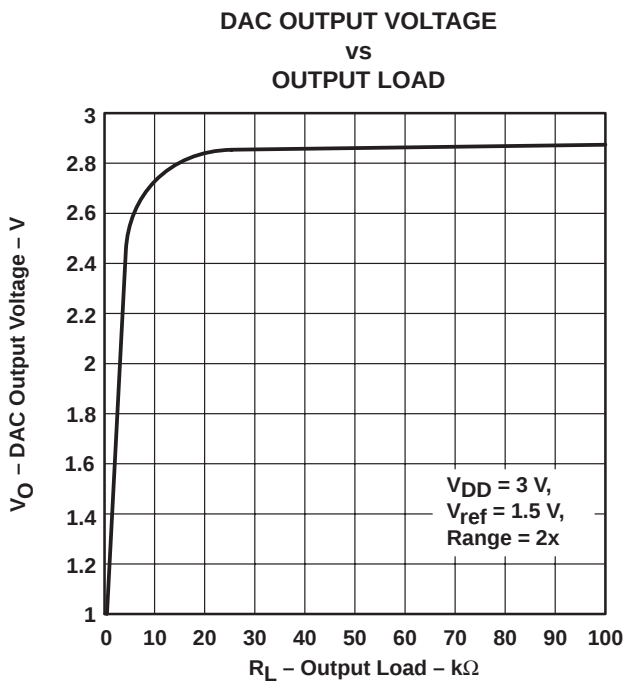


Figure 9

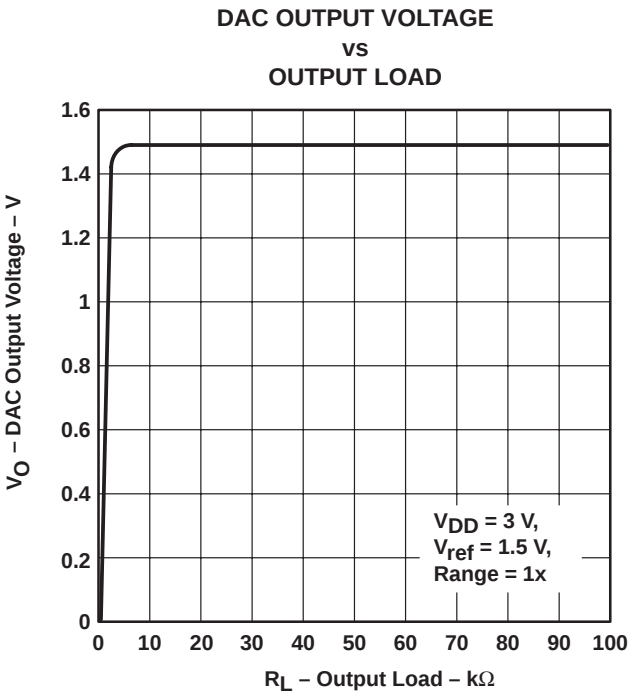


Figure 10

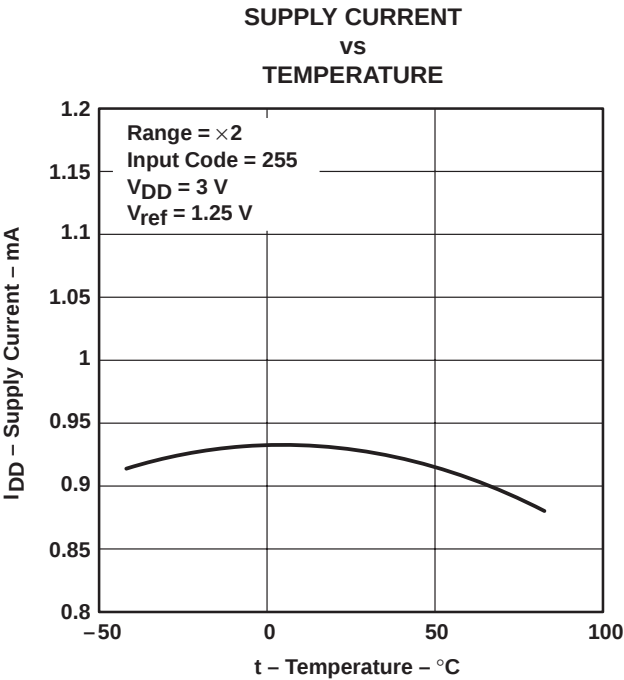
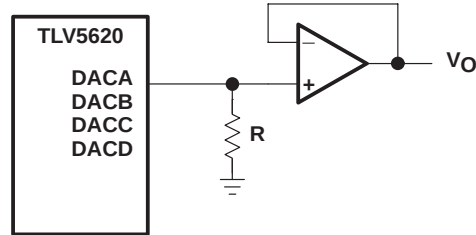


Figure 11

APPLICATION INFORMATION



NOTE A: Resistor  $R \geq 10 \text{ k}\Omega$

Figure 12. Output Buffering Scheme

## PACKAGING INFORMATION

| Orderable part number      | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|----------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">TLV5620CD</a>  | Active        | Production           | SOIC (D)   14  | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLV5620C            |
| TLV5620CD.A                | Active        | Production           | SOIC (D)   14  | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLV5620C            |
| TLV5620CDG4                | Active        | Production           | SOIC (D)   14  | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLV5620C            |
| <a href="#">TLV5620CDR</a> | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLV5620C            |
| TLV5620CDR.A               | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | TLV5620C            |
| <a href="#">TLV5620CN</a>  | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TLV5620CN           |
| TLV5620CN.A                | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | TLV5620CN           |
| <a href="#">TLV5620ID</a>  | Active        | Production           | SOIC (D)   14  | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TLV5620I            |
| TLV5620ID.A                | Active        | Production           | SOIC (D)   14  | 50   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TLV5620I            |
| <a href="#">TLV5620IDR</a> | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TLV5620I            |
| TLV5620IDR.A               | Active        | Production           | SOIC (D)   14  | 2500   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | TLV5620I            |
| <a href="#">TLV5620IN</a>  | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | TLV5620IN           |
| TLV5620IN.A                | Active        | Production           | PDIP (N)   14  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | TLV5620IN           |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLV5620IDR | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device     | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV5620IDR | SOIC         | D               | 14   | 2500 | 350.0       | 350.0      | 43.0        |

## TUBE



\*All dimensions are nominal

| Device      | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|-------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLV5620CD   | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLV5620CD.A | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLV5620CDG4 | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLV5620CN   | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLV5620CN.A | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLV5620ID   | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLV5620ID.A | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLV5620IN   | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLV5620IN.A | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |

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